

2A Sensitive SCRs

Product Summary

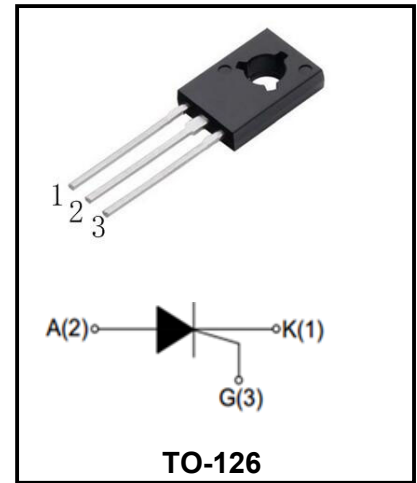
Symbol	Value	Unit
$I_{T(AV)}$	2	A
$V_{DRM} V_{RRM}$	600/800	V
I_{GT}	200	μA

Features

With high ability to withstand the shock loading of large current, Provide high dv/dt rate with strong resistance to electromagnetic interference.

Application

Power charger, T-tools, massager, solid state relay, AC Motor speed regulation and so on.



Order Information

Part Number	Package	Marking	packing	Delivery Quantity
2P4MC	TO-126	2P4M XXXX	Bag	500pcs/Bag

Absolute maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Repetitive peak off-state voltage	V_{DRM}	600/800	V
Repetitive peak reverse voltage	V_{RRM}	600/800	V
RMS on-state current	$I_{T(RMS)}$	3	A
Average on-state current	$I_{T(AV)}$	2	A
Non repetitive surge peak on-state current (full cycle, F=50Hz)	I_{TSM}	20	A
I^2t value for fusing (tp=10ms)	I^2t	2	A ² s
Critical rate of rise of on-state current ($I_G = 2 \times I_{GT}$)	di_T/dt	I - II - III 50	A/ μs
Peak gate current	I_{GM}	0.2	A
Average gate power dissipation	$P_G (AV)$	0.1	W
Junction Temperature	T_J	-40~+110	°C
Storage Temperature	T_{STG}	-40 ~+150	°C

Electrical characteristics (TA=25°C, unless otherwise noted)

Parameter	Symbol	Test Condition	Value			Unit
			Min	Typ	Max	
Gate trigger current	I_{GT}	$V_D=6V, R_L=100\Omega$ $R_{GK}=1k\Omega, Fig. 6$	10		200	μA
Gate trigger voltage	V_{GT}	$V_D=12V, R_L=100\Omega$ $R_{GK}=1k\Omega$			0.8	V
Non-triggering gate voltage	V_{GD}	$V_D=1/2V_{DRM}, R_{GK}=1k\Omega$ $T_j=110^\circ C$	0.2			V
Holding current	I_H	$V_D=24V, R_{GK}=1k\Omega, I_{TM}=4A$ $T_j=25^\circ C, Fig. 6$		1	3	mA
Latching current	I_L	$I_G=1.2I_{GT}, Fig. 6$			4	mA
Critical-rate of rise of commutation voltage	dV_D/dt	$V_D=2/3V_{DRM}, R_{GK}=1k\Omega$ $T_j=110^\circ C$	10			V/ μs

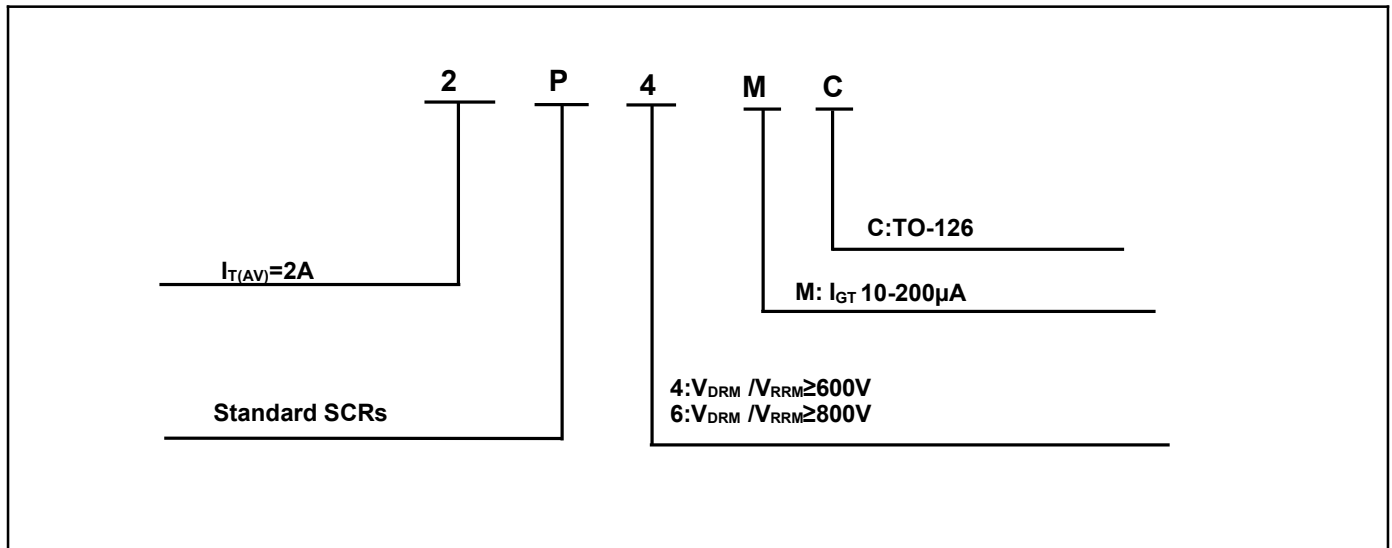
STATIC CHARACTERISTICS

On-state Voltage	V_{TM}	$I_{TM}=4A, Fig. 4$			1.55	V
Repetitive Peak Off-State Current	I_{DRM}	$V_D=V_{DRM}=V_{RRM}$	$T_j=25^\circ C$		5	μA
Repetitive Peak Reverse Current	I_{RRM}		$T_j=110^\circ C$		100	μA

THERMAL RESISTANCES

Thermal resistance	$R_{th(j-c)}$	Junction to case	TYP.	7.2	$^\circ C/W$
	$R_{th(j-a)}$	Junction to ambient	TYP.	100	$^\circ C/W$

Ordering Information



Typical Characteristics

FIG.1: Maximum power dissipation versus RMS on-state current (full cycle)

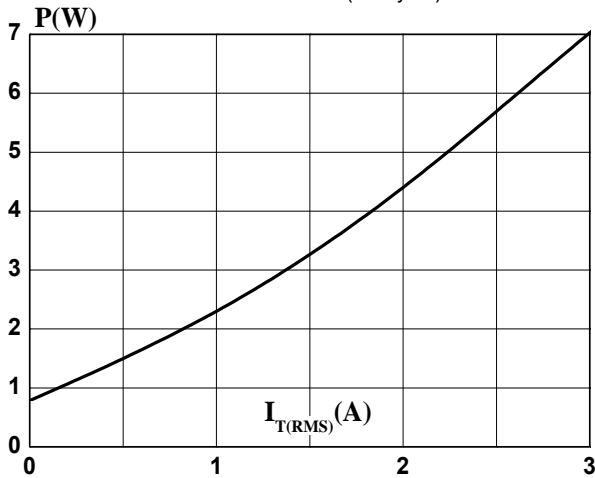


FIG.2: RMS on-state current versus case temperature (full cycle)

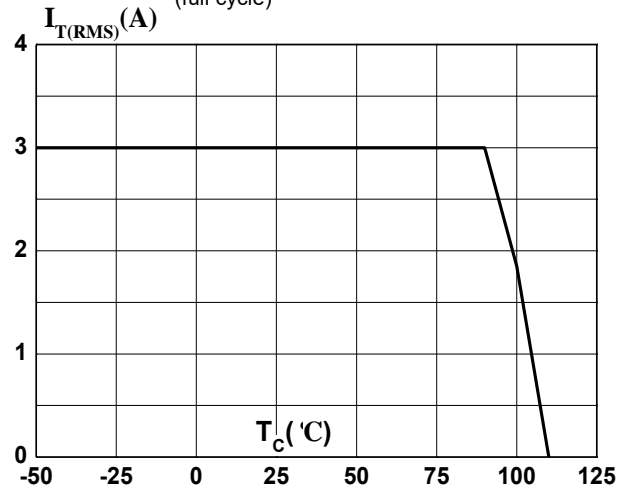


FIG.3: Surge peak on-state current versus number of cycles

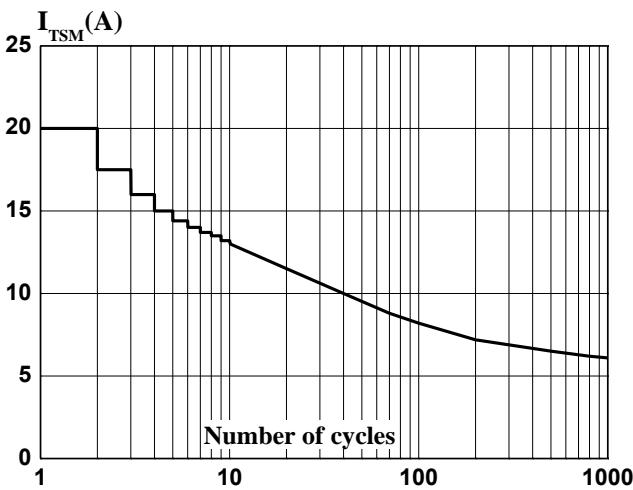


FIG.4: On-state characteristics (maximum values)

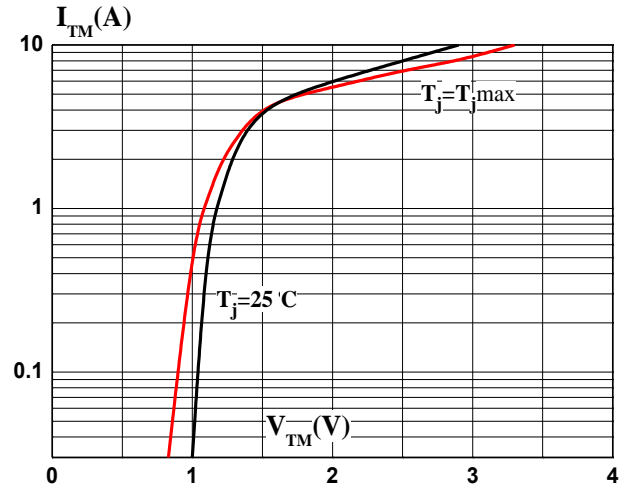


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10\text{ms}$

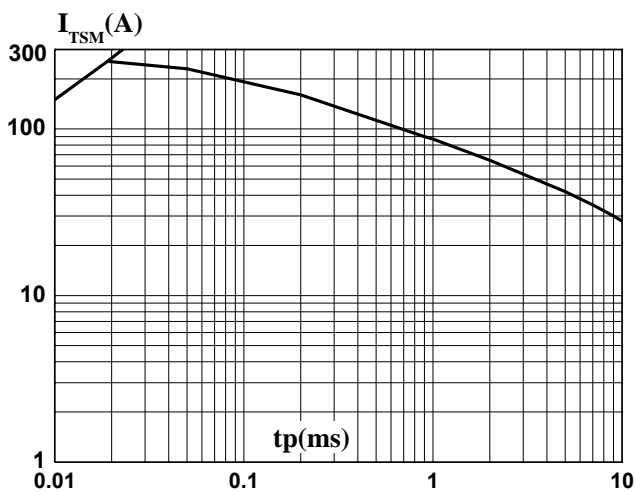
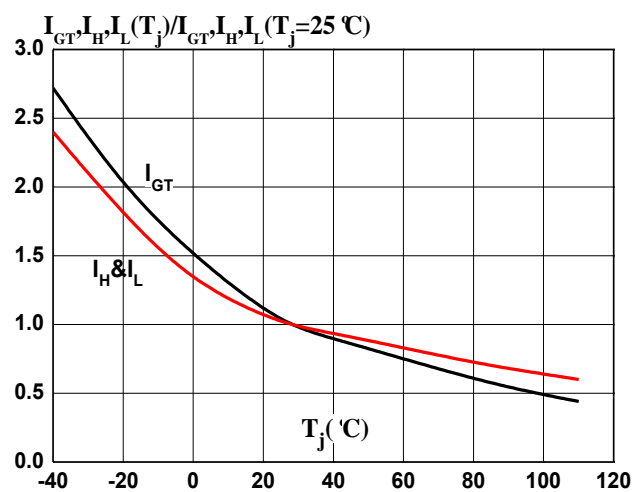


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature (typical values)



Package Information

TO-126

